

BB02-WF

CUSTOMER PRODUCT SPECIFICATION SHEET

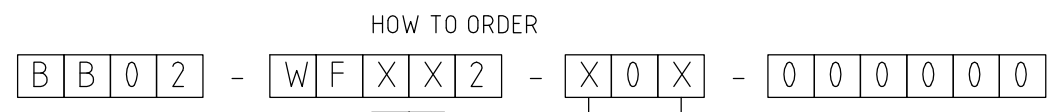
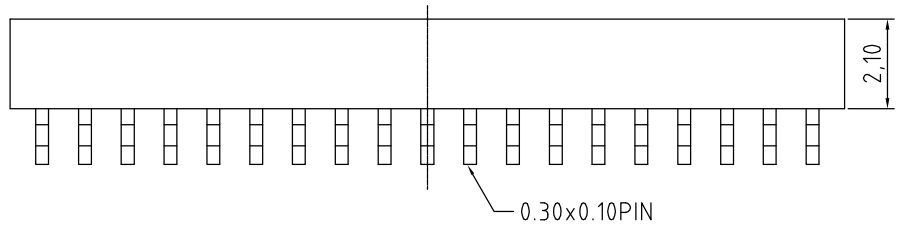
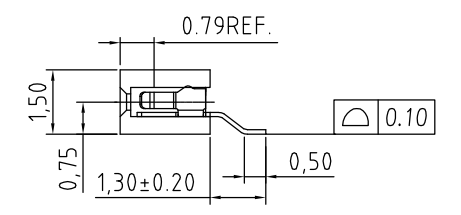
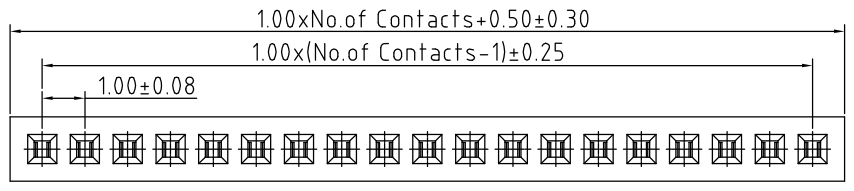


BB02-WF:- 1.00MM (0.039") SOCKET, SINGLE ROW, RIGHT ANGLE, SMT TYPE, 02 TO 35 CONTACTS

SPECIFICATIONS :
 CURRENT RATING: 1.0AMP Δ
 INSULATOR RESISTANCE: 1000 MEGOHMS MIN. Δ
 DIELECTRIC WITHSTANDING: AC 300 V Δ
 CONTACT RESISTANCE: 20m OHMS MAX. Δ
 OPERATING TEMPERATURE: -40°C TO +105°C
 CONTACT MATERIAL: PHOSPHOR BRONZE
 INSULATOR MATERIAL: THERMOPLASTIC, UL 94V-0
 STANDARD: LCP + 30%GF
 PLATING: GOLD OR TIN OVER 30-50U" NICKEL
 SOLDERABILITY IR REFLOW: 280°C FOR 10 SEC
 MANUAL SOLDER: 380°C FOR 3-5 SEC

MATES WITH: - BB02-YJ BB02-YM
 BB02-YK BB02-YN
 BB02-YL BB02-YR

NOTES:
 1. RECOMMENDED MATING PIN LENGTH = 1.5MM.



NO. OF CONTACTS: 02 to 35 Δ

CONTACT PLATING OPTIONS:
 K = GOLD FLASH (STANDARD)
 A = 10U" GOLD ON CONTACT/GOLD FLASH ON TAIL
 B = 15U" GOLD ON CONTACT/GOLD FLASH ON TAIL
 T = BRIGHT TIN
 M = MATT TIN

PACKAGING OPTIONS:
 3 = TUBE OR BOX
 4 = TUBE + FILM
 6 = TAPE & REEL
 7 = TAPE & REEL + FILM

REV.	DATE & DRN
1.0	26/02/09 - NYW RELEASE
1.1	07/07/09 - NYW CHANGE CURRENT RATING
1.2	29/07/09 - NYW ADD PLATING OPTIONS A & B
1.3	20/10/10 - NYW CHANGE MAX. PIN# 40 TO 35.
1.4	05/03/14 - NYW AMEND TOLERANCE.

Scale: 8:1	THIRD ANGLE	Unstated Tolerances: X ± 0.30 X ± 0.25 .XX ± 0.15 XXX ± 0.10	Material SEE NOTE
Drawn: NYW			
App'd: XXX	Title: SOCKET		NOT TO SCALE
Date: 5 MAR. '14	Revision: 1.4		Unit: mm

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Type BB02-WF
BB02-WF
Drawing Number:
Sheet 1 of 1
Drawing © E and O E